506343720 11/09/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT6390474

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
RYUTARO SUDA	10/21/2020
MAJU TOMURA	10/21/2020

RECEIVING PARTY DATA

Name:	TOKYO ELECTRON LIMITED	
Street Address:	reet Address: 3-1 AKASAKA 5-CHOME,	
Internal Address:	MINATO-KU,	
City:	TOKYO	
State/Country:	JAPAN	
Postal Code:	107-6325	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17092380

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 5713766333

Email: anaquadocketing@Xsensus.com

Correspondent Name: XSENSUS LLP

Address Line 1: 200 DAINGERFIELD ROAD

Address Line 2: SUITE 201

Address Line 4: ALEXANDRIA, VIRGINIA 22314

ATTORNEY DOCKET NUMBER:	14514US03
NAME OF SUBMITTER:	SHELLY LEDERLE
SIGNATURE:	/Shelly Lederle/
DATE SIGNED:	11/09/2020
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 2

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> **PATENT REEL: 054308 FRAME: 0548** 506343720

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

Attorney Docket No. 15046US01		
Title of Invention	SUBSTRATE PROCESSING METHOD AND PLASMA PROCESSING APPARATUS	
As the below na	med inventor, I hereby declare that:	
This declaration	☑ The attached application, or	
is directed to:	United States application or PCT international application number	
filed on		
	ified application was made or authorized to be made by me.	
WHEREAS, _	m the original inventor or an original joint inventor of a claimed invention in the application. Tokyo Electron Limited	
(hereinafter refe Minato-ku, To	rred to as "ASSIGNEE") having places of business at: 3-1, Akasaka 5-chome kyo 107-6325, Japan	
is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;		
NOW, THEREFORE, for good, valuable, and adequate consideration, the receipt of which is hereby acknowledged, I, by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries (including the right to claim priority under the terms of the International Convention and other relevant International Treaties and Arrangements from the aforesaid application) and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.		
I hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me had this Assignment and sale not been made.		
Further, I agree that I will communicate to said ASSIGNEE or its representatives any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.		
	nowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by ament of not more than five (5) years, or both.	
LEGAL NAMI	OF INVENTOR	
Inventor: Ryu	taro SUDA Date: Oct. 2/ 2020	
Signature:	Ryutaro Suda	

XSENSUS LLP ATTORNEYS AT LAW 200 DAINGERFIELD ROAD, SUITE 201 Alexandria, VA 22314

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

	t No. 13046USU1	
Title of Invention	SUBSTRATE PROCESSING METHOD AND PLASMA PROCESSING APPARATUS	
As the below na	med inventor, I hereby declare that:	
This declaration	The attached application, or	
is directed to: United States application or PCT international application number		
filed on		
The above-ident	ified application was made or authorized to be made by me.	
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application. WHEREAS, Tokyo Electron Limited		
(hereinafter refe	rred to as "ASSIGNEE") having places of business at: 3-1, Akasaka 5-chome, kyo 107-6325, Japan	
is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;		
NOW, THEREFORE, for good, valuable, and adequate consideration, the receipt of which is hereby acknowledged, I, by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries (including the right to claim priority under the terms of the International Convention and other relevant International Treaties and Arrangements from the aforesaid application) and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.		
I hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me had this Assignment and sale not been made.		
Further, I agree that I will communicate to said ASSIGNEE or its representatives any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.		
I hereby ack fine or imprisor	nowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by iment of not more than five (5) years, or both,	
LEGAL NAME	OF INVENTOR	
Inventor: Maj	u TOMURA Date: Opt. 21, 2224	
Signature:	Maintomaga	

XSENSUS LLP ATTORNEYS AT LAW 200 DAINGERFIELD ROAD, SUITE 201 Alexandria, VA 22314

RECORDED: 11/09/2020

PATENT REEL: 054308 FRAME: 0550